Spec. No.: RMCH-K-HTS-0001 /2

Date: 2017.4.21

Data sheet

Title: FIXED THICK FILM CHIP RESISTORS;

RECTANGULAR TYPE & HIGH POWER

Style: RMCH16,20,32,35

AEC-Q200 qualified

RoHS COMPLIANCE ITEM
Halogen and Antimony Free

Note: •Stock conditions

Temperature: $+5^{\circ}\text{C} \sim +35^{\circ}\text{C}$ Relative humidity: $25\% \sim 75\%$

The period of guarantee: Within 2 year from shipmen t by the company.

Solderability shall be satisfied.

- Product specification contained in this data sheet are subject to change at any time without notice
- •If you have any questions or a Purchasing Specification for any quality Agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

RAMAYA OHM No: RMCH-K-HTS-0001 /2

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1. Scope

1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type & high power, style of RMCH16,20,32,35

1.2 Applicable documents

JIS C 5201–1: 2011, JIS C 5201–8: 2014, JIS C 5201–8–1: 2014 IEC60115–1: 2008, IEC60115–8: 2009, IEC60115–8–1: 2014 EIAJ RC-2134C-2010

2. Classification

Type designation shall be the following form.

(Example)

1 Fixed thick film chip resistors; rectangular type & high power



2 Rated dissipation and / or dimension

3 Temperature coefficient of resistance

K	±100×10 ⁻⁶ / °C
-(Dash)	Standard

4 Rated resistance

123	E24 Series, 3 digit,	Ex. 123> 12kΩ,
1000	E96 Series, 4 digit,	Ex. 1000>100Ω
		1022> 10.2kΩ

5 Tolerance on rated resistance

D	±0.5%
F	±1%
J	±5%

6 Packaging form

B Bulk (loose package)	
TP	Paper taping
TE	Embossed taping

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3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1

Style	Rated dissipation (W)		ure coefficient of nce (10°/°C)	Rated resistance range (Ω)	Preferred number series for resistors	Tolerance on rated resistance			
		K	±100	51~1M	E24, 96	D(10 E0() E(140()			
RMCH16	0.25	Standard	+500~-200	1.0~49.9	⊏24, 90	D(±0.5%),F(±1%)			
RIVICHIO	0.23	Standard	±200	51~1M	E24	1/450/)			
		Stariuaru	+500~-200	1.0~47	E24	J(±5%)			
		K	±100	51~1M	E24.06	D(10 E0/) E(140/)			
RMCH20	0.33	Standard	+500~-200	1.0~49.9	E24, 96	D(±0.5%),F(±1%)			
RIVICHZU		Standard	±200	51~1M	E24	J(±5%)			
			+500~-200	1.0~47					
	MCH32 0.5	K	±100	51~1M	E24, 96	D(10 E0/) E(140/)			
DMCHaa		MCLIOO 0.F	Standard	+500~-200	1.0~49.9	⊏24, 90	D(±0.5%),F(±1%)		
RIVICH32			Standard	±200	51~1M	E24	1/150/)		
		Standard	+500~-200	1.0~47	EZ4	J(±5%)			
		K	±100	51~1M	E24, 96	D(±0.50/.) E(±10/.)			
RMCH35	0.75	Standard	+500~-200	1.0~49.9	E24, 90	D(±0.5%),F(±1%)			
KIVICH33	0.75	Standard	±200	51~1M	F04	1/150/)			
		`	St		Statiluatu	+500~-200	1.0~47	E24	J(±5%)

Style	Limiting element voltage (V)	Isolation voltage (V)	Category temperature range (°C)
RMCH16	150	150	
RMCH20			FE .155
RMCH32	200	500	_55~ + 155
RMCH35			

3.2 Climatic category

55/155/56 Lower category temperature -55 °C

> Upper category temperature +155 °C Duration of the damp heat, steady state test 56days

3.3 Stability class

5% Limits for change of resistance:

> -for long-term tests $\pm (5\% + 0.1\Omega)$ -for short-term tests $\pm (1\% + 0.05\Omega)$

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3.4 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

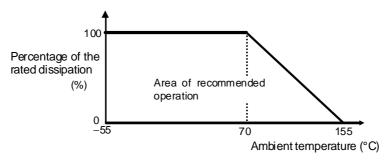


Figure-1 Derating curve

3.5 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

E: Rated voltage (V)

P: Rated dissipation (W)

R: Rated resistance (Ω)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

		1000 2				
Symbol Packaging form		Standard packaging quantity / units	Application			
	В	Bulk (loose package)		1,000 pcs.	RMCH16,20,32,35	
	TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RMCH16,20,32	
	TE	Embossed taping	8mm width, 4mm pitches	4.000 pcs.	RMCH35	

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5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

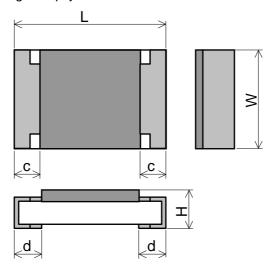


Figure-2 Table-3

Table-3					Unit: mm
Style	L	W	Н	С	d
RMCH16	1.6±0.1	0.8 +0.15 -0.05	0.45±0.10	0.3±0.2	0.3±0.1
RMCH20	2.0±0.1	1.25±0.10	0.55±0.10	0.3±0.2	0.3±0.2
RMCH32	3.1±0.1	1.6±0.15	0.55±0.10	0.4±0.25	0.5±0.25
RMCH35	3.1±0.15	2.5±0.15	0.55±0.15	0.4±0.25	0.5±0.25

5.2 Net weight (Reference)

Style	Net weight(mg)
RMCH16	2
RMCH20	5
RMCH32	9
RMCH35	16

6. Marking

The nominal resistance shall be marked in 3 digits or 4 digits and marked on over coat side.

• E24 series: 3 digits, E96 series: 4 digits

In case of the resistance value that E96 overlaps with E24, It is marked by either.

The Rated resistance of RMCH16 should not be marked in 4 digits (E96).

		5 \
Marking example	Contents	Application
123	$12\times10^3 \ [\Omega] \rightarrow 12 \ [k\Omega]$	RMCH16,20,32,35
2R2	2.2 [Ω]	Less than 10Ω of RMCH16,20,32,35
5623	$562\times10^3 [\Omega] \rightarrow 562[k\Omega]$	RMCH20,32,35
12R7	12.7 [Ω]	RMCH20,32,35

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7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1:2011.

7.2 The performance shall be satisfied in Table-4.

Table-4(1)

No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements
1	Visual examination	Sub-clause 4.4.1 Checked by visual examination.	As in 4.4.1 The marking shall be legible, as checked by visual examination.
2	Dimension Resistance	Sub-clause 4.4.2 Sub-clause 4.5	As specified in Table–3 of this specification. As in 4.5.2 The resistance value shall correspond with the rated resistance taking into account the specified tolerance.
3	Voltage proof	Sub-clause 4.7 Method: 4.6.1.4 Test voltage: Alternating voltage with a peak value of 1.42 times the insulation voltage. Duration: 60 s ± 5 s Insulation resistance Test voltage: Insulation voltage Duration: 1 min.	No breakdown or flash over $R \ge 1 \ G \ \Omega$
4	Solderability	Sub-clause 4.17 Without ageing Flux: The resistors shall be immersed in a non-activated soldering flux for 2s. Bath temperature: 235 °C ±5 °C Immersion time: 2 s ± 0.5 s	As in 4.17.4.5 The terminations shall be covered with a smooth and bright solder coating.
5	Mounting Overload (in the mounted state) Solvent resistance of the marking	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.13 The applied voltage shall be 2.5 times the rated voltage or twice the limiting element voltage, whichever is the less severe. Duration: 2 s Visual examination Resistance Sub-clause 4.30 Solvent: 2-propanol Solvent temperature: 23 °C ± 5 °C Method 1 Rubbing material: cotton wool Without recovery	No visible damage $\Delta R \le \pm (1\% + 0.05\Omega)$ Legible marking

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Table-4(2)

		Table 4(2)	
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
6	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Bound strength of the end face	Sub-clause 4.33	
	plating	Bent value: 3 mm	
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
	Final measurements	Sub-clause 4.33.6	No visible damage
		Visual examination	
7	Resistance to soldering heat	Sub-clause 4.18	
		Solder temperature: 260 °C ± 5 °C	
		Immersion time: $10 \text{ s} \pm 0.5 \text{ s}$	
		Visual examination	As in 4.18.3.4
			No sign of damage such as cracks.
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
	Component solvent resistance	Sub-clause 4.29	,
		Solvent: 2-propanol	
		Solvent temperature: 23 °C ± 5 °C	
		Method 2	
		Recovery: 48 h	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
8	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Adhesion	Sub-clause 4.32	
		Force: 5 N	
		Duration: $10 s \pm 1 s$	
		Visual examination	No visible damage
	Rapid change temperature	Sub-clause 4.19	
		Lower category temperature: -55 °C	
		Upper category temperature: +155 °C	
		Duration of exposure at each temperature: 30	
		min.	
		Number of cycles: 5 cycles.	No viethle deserve
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$

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Table-4(3)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
9	Climatic sequence	Sub-clause 4.23	
	–Dry heat	Sub-clause 4.23.2	
		Test temperature: +155 °C	
		Duration: 16 h	
		Sub-clause 4.23.3	
		Test method: 2	
		Test temperature: 55 °C	
	-Damp heat, cycle	[Severity(2)]	
	(12+12hour cycle)	Sub-clause 4.23.4	
	First cycle	Test temperature –55 °C	
		Duration: 2h	
	-Cold	Sub-clause 4.23.6	
		Test method: 2	
		Test temperature: 55 °C	
	-Damp heat, cycle	[Severity (2)]	
	(12+12hour cycle)	Number of cycles: 5 cycles	
	Remaining cycle	Sub-clause 4.23.7	
		The applied voltage shall be the rated voltage	
	-D.C. load	or the limiting element voltage whichever is	
	-b.c. load	the smaller. Duration: 1 min.	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (5\% + 0.1\Omega)$
10	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Endurance at 70 °C	Sub-clause 4.25.1	
		Ambient temperature: 70 °C ± 2 °C	
		Duration: 1000 h	
		The voltage shall be applied in cycles of 1.5 h	
		on and 0.5 h off.	
		The applied voltage shall be the rated voltage	
		or the limiting element voltage whichever is	
		the smaller.	
		Examination at 48 h, 500 h and	
		1000 h:	NI - 2-20 In de conse
		Visual examination	No visible damage
44	NA CO	Resistance	$\Delta R \le \pm (5\% + 0.1\Omega)$
11	Mounting	Sub-clause 4.31	
	Variation of resistance with	Substrate material: Epoxide woven glass	As in Table 4
	Variation of resistance with	Sub-clause 4.8	As in Table–1
	temperature	-55 °C / +20 °C	
		+20 °C / +155°C	

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Table-4(4)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
12	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Damp heat, steady state	Sub-clause 4.24	
		Ambient temperature: 40 °C ± 2 °C	
		Relative humidity: 93 $^{+2}_{-3}$ %	
		a) 1st group: without voltage applied.	
		b) 2nd group: The d. c. voltage shall be	
		applied continuously.	
		The voltage shall be accordance with	
		Sub-clause 4.24.2.1 b). without polarizing	
		voltage [4.24.2.1, c)]	
		Visual examination	No visible damage
			Legible marking
		Resistance	$\Delta R \le \pm (5\% + 0.1\Omega)$
13	Dimensions (detail)	Sub-clause 4.4.3	As in Table–3
	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Endurance at upper category	Sub-clause 4.25.3	
	temperature	Ambient temperature:155 °C ± 2 °C	
		Duration: 1000 h	
		Examination at 48 h, 500 h and	
		1000 h:	
		Visual examination	No visible damage
		Resistance	$\Delta R \leq \pm (5\% + 0.1\Omega)$

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8. Taping

- 8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 8.2 Taping dimensions
- 8.2.1 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.

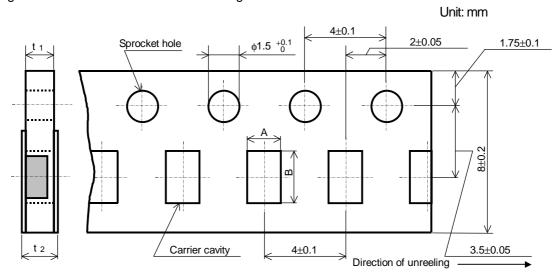


Figure-3

	Unit: mm			
Style	Α	В	t 1	t 2
RMCH16	1.15 ± 0.15	1.9 ± 0.2	0.6 ± 0.1	0.8max.
RMCH20	1.65±0.15	2.5±0.2	0.8±0.1	1.0max.
RMCH32	2.00±0.15	3.6±0.2	U.O±U. I	

8.2.2 Embossed taping dimensions shall be in accordance with Figure-4 and Table-6.

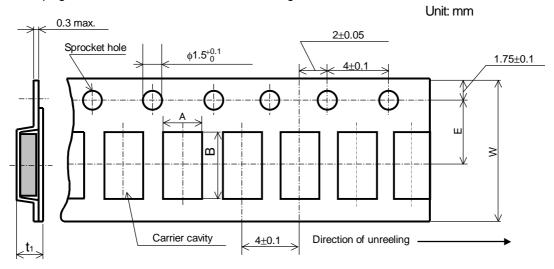


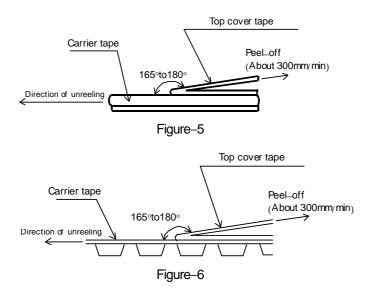
Figure 4

Table-6				Unit: mm	
Style	Α	В	W	Е	t 1
RMCH35	2.85±0.20	3.5±0.2	8.0±0.3	3.5±0.05	1.0±0.2

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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RMCH16,20,32: Figure–5, RMCH35: Figure–6.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

 The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

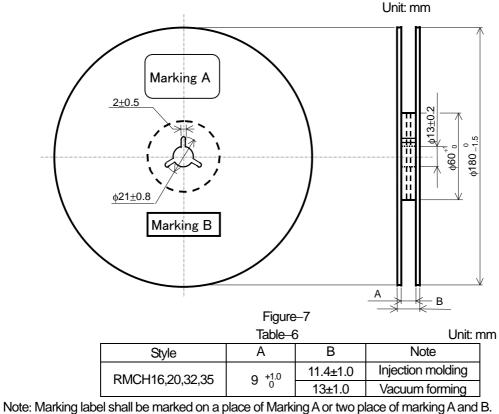


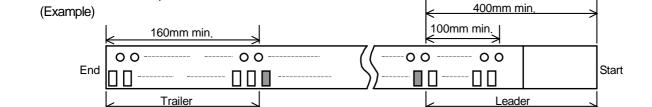
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8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-7 and Table-6. Plastic reel (Based on EIAJ ET-7200C)





Direction of unreeling

Figure-8

9. Marking on package

The label of a minimum package shall be legibly marked with follows.

9.1 Marking A

(1) Classification

8.4 Leader and trailer tape.

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark

9.2 Marking B (KAMAYA Control label)

单击下面可查看定价,库存,交付和生命周期等信息

>>Kamaya(釜屋电机)